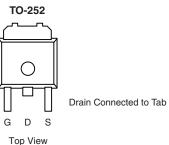


Vishay Siliconix

N-Channel 60 V (D-S), MOSFET

PRODUCT SUMMARY						
V _{DS} (V)	R_{DS(on)} (Ω)	I _D (A) ^a	Q _g (Typ.)			
60	0.031 at V _{GS} = 10 V	9.1	6.5 nC			
00	0.045 at V _{GS} = 4.5 V	7.6	0.5 110			



FEATURES

- Halogen-free According to IEC 61249-2-21 Definition
- TrenchFET[®] Power MOSFET
- 100 % R_g and UIS Tested •
- Compliant to RoHS Directive 2002/95/EC

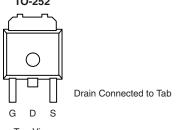
GC

APPLICATIONS

DC/DC Converters



RoHS COMPLIANT HALOGEN FREE



Ordering Information: SUD23N06-31-GE3 (Lead (Pb)-free and Halogen-free)

N-Channel MOSFET

D

ABSOLUTE MAXIMUM RATINGS	S (T _A = 25 °C, unles	ss otherwise n	oted)		
Parameter	Symbol	Limit	Unit		
Drain-Source Voltage	V _{DS}	60	v		
Gate-Source Voltage		V _{GS}	± 20	v	
	T _C = 25 °C		21.4		
Continuous Drain Current (T. -150 °C)	T _C = 70 °C	1	17.1		
Continuous Drain Current (T _J = 150 °C)	T _A = 25 °C	Ι _D	9.1 ^a		
	T _A = 70 °C		7.6 ^a	А	
Pulsed Drain Current		I _{DM}	50		
	T _C = 25 °C	I	20.8		
Continuous Source-Drain Diode Current	T _A = 25 °C	۱ _S	3.8 ^a		
Single Pulse Avalanche Current	L = 0.1 mH	I _{AS}	20		
Avalanche Energy	L = 0.1 min	E _{AS}	20	mJ	
	T _C = 25 °C		31.25		
Maximum Dawar Dissinction	T _C = 70 °C		20	w	
Maximum Power Dissipation	T _A = 25 °C	PD	5.7 ^a	vv	
	T _A = 70 °C		3.6 ^a		
Operating Junction and Storage Temperature Ra	T _J , T _{stg}	- 55 to 150	°C		

THERMAL RESISTANCE RATINGS						
Parameter		Symbol	Typical	Maximum	Unit	
Maximum Junction-to-Ambient ^a	$t \le 10 s$	R _{thJA}	18	22	°C/W	
Maximum Junction-to-Case	Steady State	R _{thJC}	3.2	4.0	0/10	

Notes:

a. Surface mounted on 1" x 1" FR4 board, t \leq 10 s.

SUD23N06-31

Vishay Siliconix



Parameter	Symbol	Test Conditions	Min.	Тур.	Max.	Unit	
Static							
Drain-Source Breakdown Voltage	V _{DS}	$V_{GS} = 0 \text{ V}, I_{D} = 250 \mu\text{A}$	60			V	
V _{DS} Temperature Coefficient	$\Delta V_{DS}/T_{J}$			65		m\//0/	
V _{GS(th)} Temperature Coefficient	$\Delta V_{GS(th)}/T_J$	I _D = 250 μA		- 6.3		mV/°C	
Gate-Source Threshold Voltage	V _{GS(th)}	$V_{DS} = V_{GS}, I_{D} = 250 \ \mu A$	1.0		3.0	V	
Gate-Source Leakage	I _{GSS}	$V_{DS} = 0 V, V_{GS} = \pm 20 V$			± 100	nA	
Zara Cata Valtaga Drain Current		$V_{DS} = 60 \text{ V}, \text{ V}_{GS} = 0 \text{ V}$			1		
Zero Gate Voltage Drain Current	I _{DSS}	$V_{DS} = 60 \text{ V}, \text{ V}_{GS} = 0 \text{ V}, \text{ T}_{J} = 70 ^{\circ}\text{C}$		20		- μΑ	
On-State Drain Current ^a	I _{D(on)}	$V_{DS} \ge 5 \text{ V}, \text{ V}_{GS} = 10 \text{ V}$	50			A	
Drain Course On State Desistance		V _{GS} = 10 V, I _D = 15 A	0.025 0.03		0.031		
Drain-Source On-State Resistance ^a	R _{DS(on)}	V _{GS} = 4.5 V, I _D = 10 A		0.037	0.045	Ω	
Forward Transconductance ^a	9 _{fs}	V _{DS} = 15 V, I _D = 15 A		20		S	
Dynamic ^b		·					
Input Capacitance	C _{iss}			670		pF	
Output Capacitance	C _{oss}	V _{DS} = 25 V, V _{GS} = 0 V, f = 1 MHz		140			
Reverse Transfer Capacitance	C _{rss}			60			
Total Cata Charge	0	$V_{DS} = 30$ V, $V_{GS} = 10$ V, $I_{D} = 23$ A		11	17		
Total Gate Charge	Qg			6.5	13	nC	
Gate-Source Charge	Q _{gs}	$V_{DS} = 30$ V, $V_{GS} = 4.5$ V, $I_{D} = 23$ A		3.0			
Gate-Drain Charge	Q _{gd}			3.0			
Gate Resistance	Rg	f = 1 MHz		1.6	3.2	Ω	
Turn-On Delay Time	t _{d(on)}			18	30		
Rise Time	t _r	V_{DD} = 30 V, R_L = 1.3 Ω		250	400		
Turn-Off Delay Time	t _{d(off)}	$I_D \cong 23$ A, V_{GEN} = 4.5 V, R_g = 1 Ω		35	55		
Fall Time	t _f			68	110		
Turn-On Delay Time	t _{d(on)}			8	15	ns	
Rise Time	t _r	V_{DD} = 30 V, R_L = 1.3 Ω		15	25	_	
Turn-Off Delay Time	t _{d(off)}	$\text{I}_\text{D}\cong$ 23 A, V_GEN = 10 V, R_g = 1 Ω		30	45		
Fall Time	t _f			25	40		
Drain-Source Body Diode Characteris	tics						
Continuous Source-Drain Diode Current	۱ _S	T _C = 25 °C			20.8	^	
Pulse Diode Forward Current ^a	I _{SM}				50	A	
Body Diode Voltage	V _{SD}	I _S = 15 A		1.0	1.5	V	
Body Diode Reverse Recovery Time	t _{rr}			30	60	ns	
Body Diode Reverse Recovery Charge	Q _{rr}			35	70	nC	
Reverse Recovery Fall Time	ta	l _F = 15 A, dl/dt = 100 A/μs, T _J = 25 °C		20			
Reverse Recovery Rise Time	t _b			10		ns	

Notes:

a. Pulse test; pulse width \leq 300 $\mu s,$ duty cycle \leq 2 %.

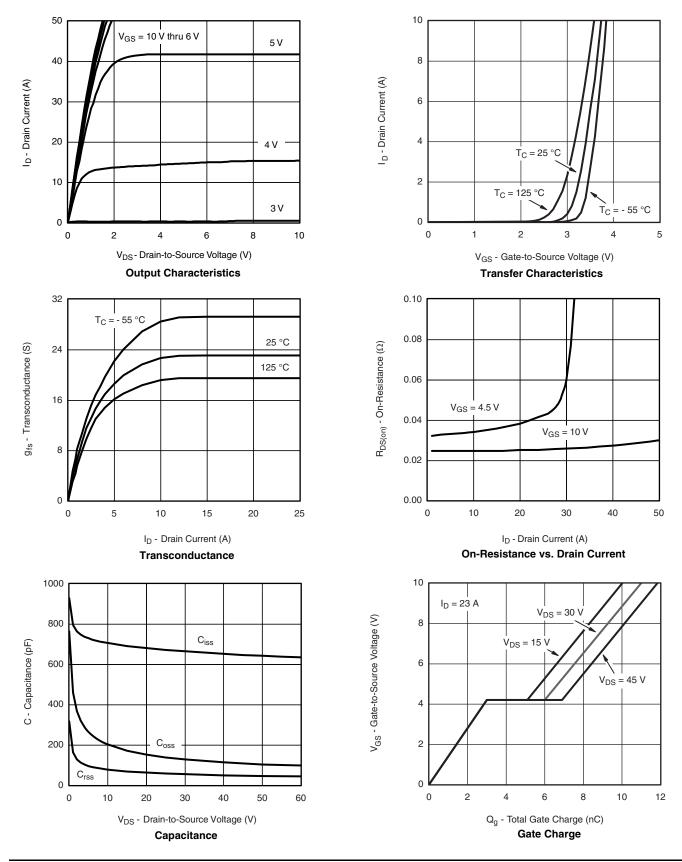
b. Guaranteed by design, not subject to production testing.

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.



SUD23N06-31 Vishay Siliconix

TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



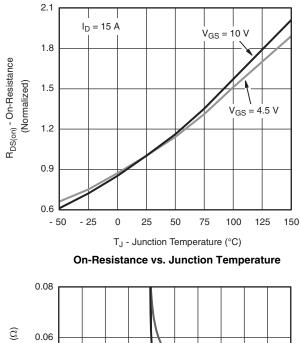
Document Number: 68857 S11-0181-Rev. B, 07-Feb-11

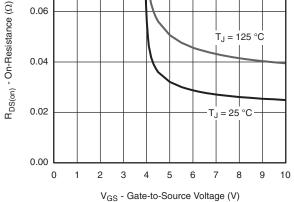
SUD23N06-31



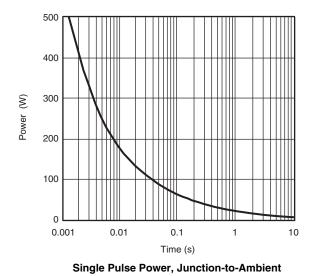
Vishay Siliconix

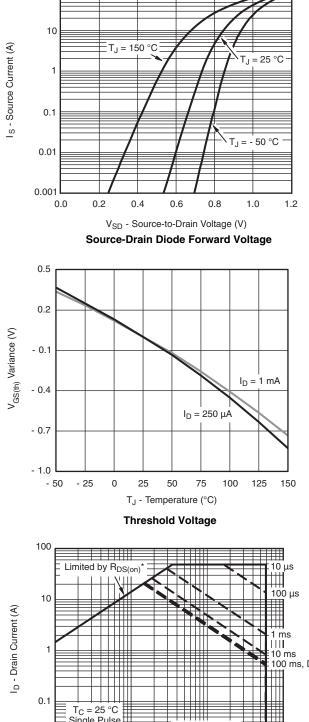
TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



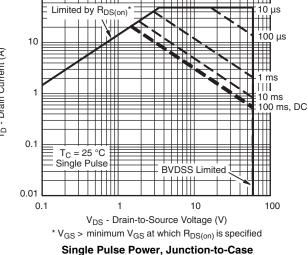








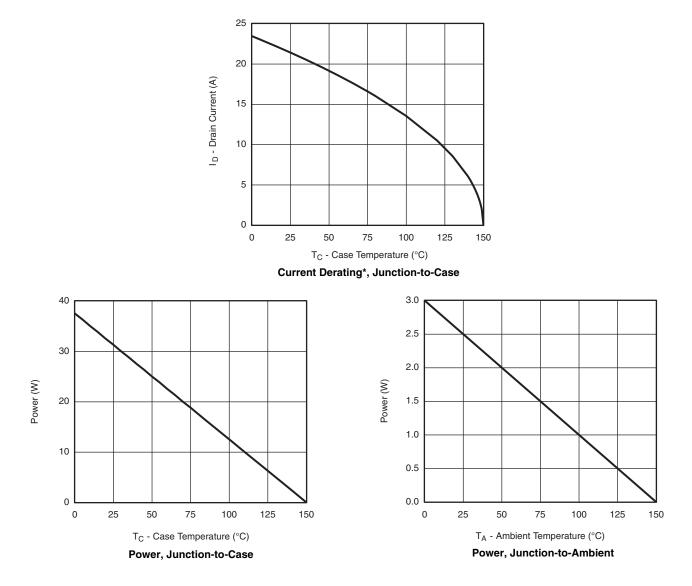
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SUD23N06-31 Vishay Siliconix

TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

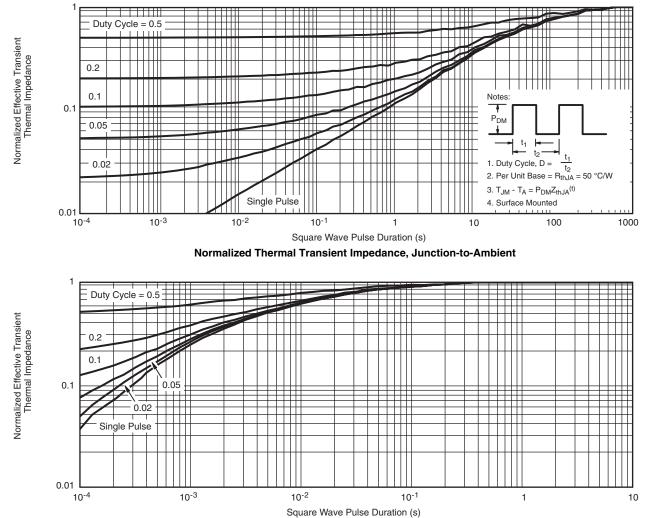


* The power dissipation P_D is based on $T_{J(max)} = 150$ °C, using junction-to-case thermal resistance, and is more useful in settling the upper dissipation limit for cases where additional heatsinking is used. It is used to determine the current rating, when this rating falls below the package limit.

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TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

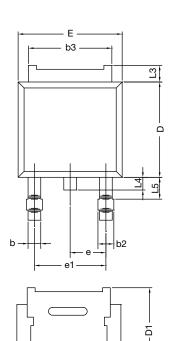


Normalized Thermal Transient Impedance, Junction-to-Case

Vishay Siliconix maintains worldwide manufacturing capability. Products may be manufactured at one of several qualified locations. Reliability data for Silicon Technology and Package Reliability represent a composite of all qualified locations. For related documents such as package/tape drawings, part marking, and reliability data, see www.vishay.com/ppg268857.







E1

TO-252AA Case Outline

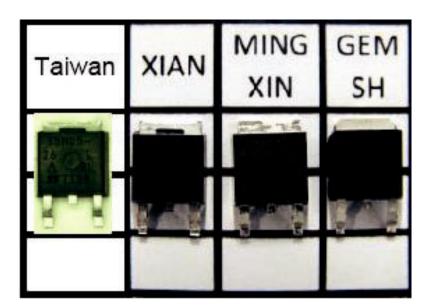
	MILLIMETERS		INCHES		
DIM.	MIN.	MAX.	MIN.	MAX.	
А	2.18	2.38	0.086	0.094	
A1	-	0.127	-	0.005	
b	0.64	0.88	0.025	0.035	
b2	0.76	1.14	0.030	0.045	
b3	4.95	5.46	0.195	0.215	
С	0.46	0.61	0.018	0.024	
C2	0.46	0.89	0.018	0.035	
D	5.97	6.22	0.235	0.245	
D1	4.10	-	0.161	-	
E	6.35	6.73	0.250	0.265	
E1	4.32	-	0.170	-	
Н	9.40	10.41	0.370	0.410	
е	2.28 BSC		0.090 BSC		
e1	4.56	BSC	0.180 BSC		
L	1.40	1.78	0.055	0.070	
L3	0.89	1.27	0.035	0.050	
L4	-	1.02	-	0.040	
L5	1.01	1.52	0.040	0.060	
ECN: T13-0359-Rev. O, 03-Jun-13 DWG: 5347					

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Notes

• Dimension L3 is for reference only.

• Xi'an, Mingxin, and GEM SH actual photo.



Revision: 03-Jun-13

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Vishay Siliconix

RECOMMENDED MINIMUM PADS FOR DPAK (TO-252)



Recommended Minimum Pads Dimensions in Inches/(mm)

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Vishay

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